



- High Accuracy Temperature Sensor
- 16/24 bit Resolution
- Low Power
- SPI/I2C Interface
- QFN16 Package



## **DESCRIPTION**

The TSYS01 is a single chip, versatile, new technology temperature sensor. The TSYS01 provides factory calibrated temperature information. It includes a temperature sensing chip and a 24 bit  $\Delta\Sigma$ -ADC. The essence of the digital 24 bit temperature value and the internal factory set calibration values lead to highly accurate temperature information accompanied by high measurement resolution.

The TSYS01 can be interfaced to any microcontroller by an I<sup>2</sup>C or SPI interface. This microcontroller has to calculate the temperature result based on the ADC values and the calibration parameters.

The basic working principle is:

- Converting temperature into digital 16/24 bit ADC value
- Providing calibration coefficients
- Providing ADC value and calibration coefficients by SPI or I<sup>2</sup>C interface.

## FEATURES APPLICATIONS

High Accuracy  $\pm 0.1^{\circ}$ C @ Temp.:  $-5^{\circ}$ C ...  $+50^{\circ}$ C Adjustment of high accuracy temp. range on request Low Current, <12.5  $\mu$ A (standby < 0.14  $\mu$ A) SPI /  $I^{2}$ C Interface

Small Package: QFN16

Operating Temperature Range: -40°C ... +125°C

Industrial Control
Replacement of Thermistors and NTCs
Heating / Cooling Systems
HVAC



## **ABSOLUTE MAXIMUM RATINGS**

Absolute maximum ratings are limiting values of permitted operation and should never be exceeded under the worst possible conditions either initially or consequently. If exceeded by even the smallest amount, instantaneous catastrophic failure can occur. And even if the device continues to operate satisfactorily, its life may be considerably shortened.

| Parameter             | Symbol | Conditions   | Min  | Тур    | Max   | Unit |
|-----------------------|--------|--|------|--------|-------|------|
| Supply Voltage        | VDD    |  | -0.3 |        | +3.6  | V    |
| Operating Temperature | Тор    |  | -40  |        | +125  | °C   |
| Storage temperature   | Tstor  |  | -55  |        | +150  | °C   |
| ESD rating            | ESD    | Human Body Model (HBM)<br>pin to pin incl. VDD & GND | -4   |        | +4    | kV   |
| Humidity              | Hum    |  | Non  | conder | nsing |      |

## **OPERATING CONDITIONS**

| Parameter                          | Symbol            | Conditions Min Typ M                            |      | Max          | Unit         |          |
|------------------------------------|-------------------|---|------|--------------|--------------|----------|
| Operating Supply Voltage           | $V_{DD}$          | stabilized                                      | 2.2  |              | 3.6          | V        |
| High Accuracy Supply Voltage       | $V_{DD}$          | To achieve Acc1                                 | 3.2  |              | 3.4          | V        |
| Supply Current                     | I <sub>DD</sub>   | 1 sample per second                             |      |              | 12.5         | μΑ       |
| Standby current                    | IS                | No conversion, VDD = 3V<br>T = 25°C<br>T = 85°C |      | 0.02<br>0.70 | 0.14<br>1.40 | μΑ<br>μΑ |
| Peak Supply Current                | $I_{DD}$          | During conversion                               |      | 1.4          |              | mΑ       |
| Conversion time                    | T <sub>CONV</sub> |   | 7.40 | 8.22         | 9.04         | ms       |
| Serial Data Clock SPI              | F <sub>SCLK</sub> |   |      |              | 20           | MHz      |
| Serial Data Clock I <sup>2</sup> C | F <sub>SCL</sub>  |   |      |              | 400          | kHz      |
| VDD Capacitor                      |                   | Place close to the chip                         |      | 100nF        |              |          |

## **OPERATIONAL CHARACTERISTICS**

If not otherwise noted, 3.3V supply voltage is applied.

| Parameter                 | Symbol            | Conditions   | Min  | Тур | Max  | Unit |
|---------------------------|-------------------|--|------|-----|------|------|
| Temp. Measurement Range   | T <sub>RANG</sub> |  | -40  |     | 125  | °C   |
| Accuracy 1                | T <sub>ACC1</sub> | $-5^{\circ}$ C < T < $+50^{\circ}$ C<br>V <sub>DD</sub> = 3.2V - 3.4V  | -0.1 |     | +0.1 | °C   |
| Accuracy 2                | T <sub>ACC2</sub> | -40°C < T < $+125$ °C<br>V <sub>DD</sub> = 3.2V $-3.4$ V   | -0.5 |     | +0.5 | °C   |
| Power Supply Reject Ratio | PSRR              | $V_{DD} = 2.7 - 3.6$<br>T = 25°C, C = 100nF  |      |     | 0.2  | °C   |
| Temperature Resolution    | T <sub>RES</sub>  |  |      |     | 0.01 | °C   |
| Time Constant             | $T_{liquid}$      | $t_{63} (t_1 \rightarrow t_2)$<br>$t_1 = 25^{\circ}\text{C (air 0m/s)}$<br>$t_2 = 75^{\circ}\text{C (liquid)}$<br>PCB 900mm <sup>2</sup> x 1.5mm FR4           |      | 3   |      | S    |
| Time Constant             | T <sub>air</sub>  | $t_{63} (t_1 \rightarrow t_2)$<br>$t_1 = 25^{\circ}\text{C (air 0m/s)}$<br>$t_2 = 75^{\circ}\text{C (air stream 60m/s)}$<br>PCB 900mm <sup>2</sup> x 1.5mm FR4 |      | 4   |      | S    |
| Self Heating              | SH₁               | 10 samples/s, 60s, still air   |      |     | 0.02 | °C   |



## **ANALOGUE TO DIGITAL CONVERTER**

| Parameter       | Symbol | Conditions | Min  | Тур  | Max  | Unit |
|-----------------|--------|------------|------|------|------|------|
| Output Word     |        |            |      | 24   |      | bit  |
| Conversion Time | tc     |            | 7.40 | 8.22 | 9.04 | ms   |

## **DIGITAL INPUTS (SCLK, SDI, CSB, PS)**

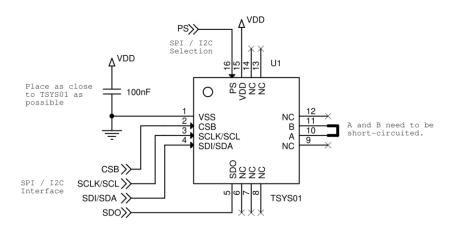
| Parameter                      | Symbol           | Conditions         | Min          | Тур | Max          | Unit |
|--------------------------------|------------------|--------------------|--------------|-----|--------------|------|
| Input High Voltage             | $V_{IH}$         | $V_{DD} = 2.23.6V$ | $0.7 V_{DD}$ |     | $V_{DD}$     | V    |
| Input Low Voltage              | $V_{IL}$         | $V_{DD} = 2.23.6V$ | $0.0~V_{DD}$ |     | $0.3 V_{DD}$ | V    |
| CS low to first SCLK rising    | t <sub>CSL</sub> |                    | 21           |     |              | ns   |
| CS high to first SCLK rising   | t <sub>CSH</sub> |                    | 21           |     |              | ns   |
| SDI setup to first SCLK rising | T <sub>DSO</sub> |                    | 6            |     |              | ns   |
| SDI hold to first SCLK rising  | $T_{DO}$         |                    | 6            |     |              | ns   |

## **DIGITAL OUTPUTS (SDA, SDO)**

| Parameter                      | Symbol          | Conditions                | Min          | Тур | Max          | Unit |
|--------------------------------|-----------------|---------------------------|--------------|-----|--------------|------|
| Output High Voltage            | V <sub>OH</sub> | I <sub>Source</sub> = 1mA | $0.8~V_{DD}$ |     | $V_{DD}$     | V    |
| Output Low Voltage             | $V_{OL}$        | $I_{Sink} = 1mA$          | $0.0~V_{DD}$ |     | $0.2 V_{DD}$ | V    |
| SDO setup to first SCLK rising | t <sub>QS</sub> |                           | 10           |     |              | ns   |
| SDO hold to first SCLK rising  | t<br>QH         |                           | 0            |     |              | ns   |



## **CONNECTION DIAGRAM**



## **PIN FUNCTION TABLE**

| Pin     | Name     | Туре | Function  |  |
|---------|----------|------|---|--|
| 1       | VSS      | G    | Ground  |  |
| 2       | CSB      | DI   | SPI: Chip Select (active low) I <sup>2</sup> C: Address Selection |  |
| 3       | SCLK/SCL | DI   | SPI: Serial Data Clock<br>I₂C: Serial Data Clock                  |  |
| 4       | SDI/SDA  | DIO  | SPI: Serial Data Input<br>I₂C: Data Input / Output                |  |
| 5       | SDO      | DO   | SPI: Serial Data Output   |  |
| 6 – 9   | NC       |      | Not connected / Do not connect                                    |  |
| 10      | Α        | I    | Connect Pin10 with Pin11  |  |
| 11      | В        | I    | Connect Pin11 with Pin10  |  |
| 12 – 14 | NC       |      | Not connected / Do not connect                                    |  |
| 15      | VDD      | Р    | Supply Voltage  |  |
| 16      | PS       | DI   | Communication protocol select (0=SPI, 1=I <sup>2</sup> C)         |  |



#### INTERFACE DESCRIPTION

### **PROTOCOL SELECTION**

PS pin input level has to be defined in dependence to protocol selection.

- PS = 0 activates SPI.
- PS = 1 activates I<sup>2</sup>C.

### I<sup>2</sup>C INTERFACE

A I<sup>2</sup>C communication message starts with a start condition and it is ended by a stop condition. Each command consists of two bytes: the address byte and command byte.

### I<sup>2</sup>C ADDRESS SELECTION

The I<sup>2</sup>C address can be selected by CSB pin.

- CSB=1 then the address is 1110110x.
- CSB=0 the address is 1110111x.

Therefore, two TSYS01 can be interfaced on the same I<sup>2</sup>C bus.

#### **SPI INTERFACE**

The serial interface is a 4-wire SPI bus, operating as a slave. CS (chip select), SCLK (serial clock), SDI (serial data in), and SDO (serial data out) are used to interact with the SPI master.

Communication with the chip starts when CS is pulled to low and ends when CS is pulled to high. SCLK is controlled by the SPI master and idles low (SCLK low on CS transitions, mode 0).

A mode where the clock alternatively idles high is also supported (mode 3).

#### **COMMANDS**

The commands are the same for SPI and I<sup>2</sup>C interface.

There are four commands:

- Reset
- Read PROM (calibration parameters)
- Start ADC Temperature conversion
- Read ADC Temperature result

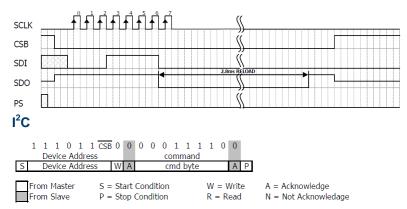
| Command                          | Hex Value |
|----------------------------------|-----------|
| Reset                            | 0x1E      |
| Start ADC Temperature Conversion | 0x48      |
| Read ADC Temperature Result      | 0x00      |
| PROM Read Address 0              | 0xA0      |
| PROM Read Address 1              | 0xA2      |
| PROM Read Address 2              | 0xA4      |
| PROM Read Address 3              | 0xA6      |
| PROM Read Address 4              | 0xA8      |
| PROM Read Address 5              | 0xAA      |
| PROM Read Address 6              | 0xAC      |
| PROM Read Address 7              | 0xAE      |



#### **RESET SEQUENCE**

The Reset sequence has to be sent once after power-on. It can be also used to reset the device ROM from an unknown condition.

#### **SPI**

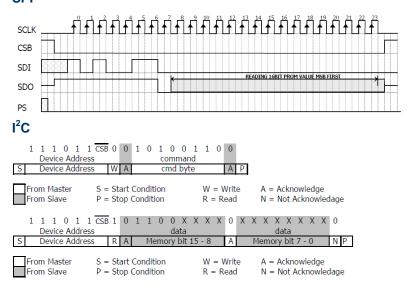


### **PROM READ SEQUENCE**

The PROM Read command consists of two parts. First command sets up the system into PROM read mode. The second part gets the data from the system.

Below examples are sequences to read address 3 (command 0xA6).

#### **SPI**



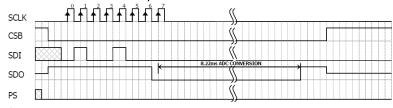


#### **CONVERSION SEQUENCE**

A conversion has to be started by sending this command. The sensor stays busy until conversion is done. When conversion is finished the data can be accessed by using ADC read command

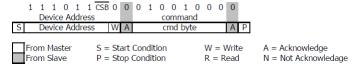
#### SP

The last clock will start the conversion which TSYS01 indicates by pulling SDO low. SDO goes high when conversion is completed.



I<sup>2</sup>C

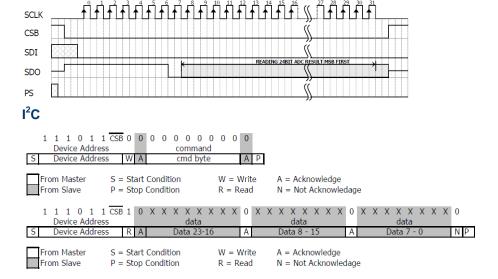
When the command is sent the TSYS01 stays busy until the conversion is done. All other commands except the reset command will not be executed during this time. When the conversion is finished the data can be accessed by sending a ADC read command, when an acknowledge appears from TSYS01.



#### **READ ADC RESULT**

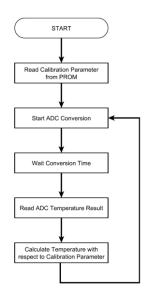
After the conversion command the ADC result is read using ADC read command. Repeated ADC read commands, or command executed without prior conversion will return all 0 as result.

#### SPI





## **TEMPERATURE CALCULATION**



### **CALIBRATION PARAMETER**

| Variable       | Description                              | Command | Size / bit | Min | Max   | Example |
|----------------|--|---------|------------|-----|-------|---------|
| k <sub>4</sub> | Coefficient k <sub>4</sub> of polynomial | 0xA2    | 16         | 0   | 65535 | 28446   |
| k <sub>3</sub> | Coefficient k <sub>3</sub> of polynomial | 0xA4    | 16         | 0   | 65535 | 24926   |
| k <sub>2</sub> | Coefficient k <sub>2</sub> of polynomial | 0xA6    | 16         | 0   | 65535 | 36016   |
| k <sub>1</sub> | Coefficient k <sub>1</sub> of polynomial | 0xA8    | 16         | 0   | 65535 | 32791   |
| $k_0$          | Coefficient k <sub>0</sub> of polynomial | 0xAA    | 16         | 0   | 65535 | 40781   |

### **TEMPERATURE POLYNOMAL**

ADC24: ADC value ADC16: ADC24 / 256

T / °C = 
$$(-2)$$
 \*  $k_4$  \*  $10^{-21}$  \*  $ADC16^4$  +  $4$  \*  $k_3$  \*  $10^{-16}$  \*  $ADC16^3$  +  $(-2)$  \*  $k_2$  \*  $10^{-11}$  \*  $ADC16^2$  +  $1$  \*  $k_1$  \*  $10^{-6}$  \*  $ADC16$  +  $(-1.5)$  \*  $k_0$  \*  $10^{-2}$ 

#### **EXAMPLE**

*ADC24*: 9378708

T / °C =

*ADC16*: 9378708 / 256 = 36636

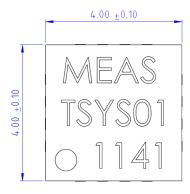
10.59

T / °C = 
$$(-2)$$
 \* 28446 \*  $10^{-21}$  \* 36636<sup>4</sup> + 4 \* 24926 \*  $10^{-16}$  \* 36636<sup>3</sup> +  $(-2)$  \* 36016 \*  $10^{-11}$  \* 36636<sup>2</sup> + 1 \* 32791 \*  $10^{-6}$  \* 36636 +  $(-1.5)$  \* 40781 \*  $10^{-2}$ 



## **DIMENSIONS**

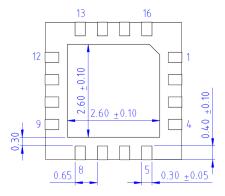
## **TOP VIEW**



## **SIDE VIEW**

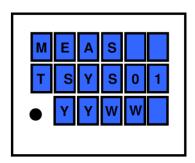


## **BOTTOM VIEW**



## **MARKING**

| Line | Description               | Example |
|------|---------------------------|---------|
| 1    | Manufacturer              | MEAS    |
| 2    | Product Name              | TSYS01  |
| 3    | Pin 1 Dot, Date Code YYWW | 1141    |





### ORDER INFORMATION

Please order this product using following:

Part Number Part Description

G-NICO-018 TSYS01 Digital Temperature Sensor

### **EMC**

Due to the use of these modules for OEM application no CE declaration is done.

Especially line coupled disturbances like surge, burst, HF etc. cannot be removed by the module due to the small board area and low price feature. There is no protection circuit against reverse polarity or over voltage implemented.

The module will be designed using capacitors for blocking and ground plane areas in order to prevent wireless coupled disturbances as good as possible.

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